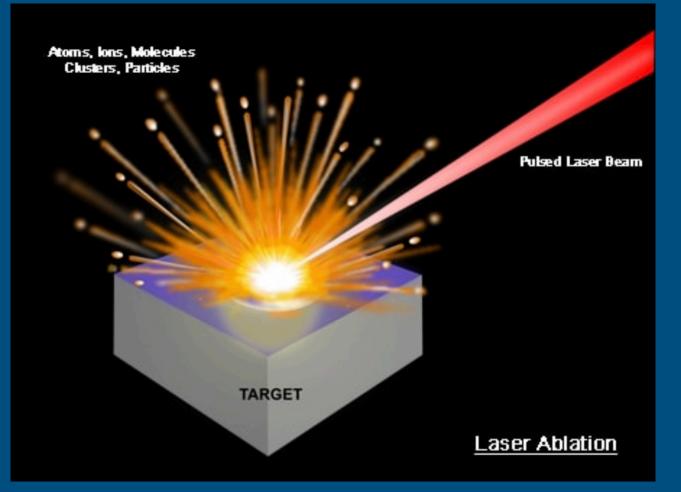
## Spectral Laser Elemental Analyzer

Group 1 Senior Design 2: Spring 2024



#### Project Scope

Develop a low-cost, high resolution, laser induced break-down spectroscopy system for the elemental analysis of in-organic samples.

#### The Team



Benjamin Logan PSE



Liam Collins ECE

Faisal Abdullah Salim Al-Quaiti ECE





#### Introduction

The proposed system uses an Nd:YAG laser, which is focused through an optical system to strike a sample, generating plasma.

The light emission from the sample is guided into a Czerny-Turner spectrometer for diffraction and spectral analysis. The plasma bloom is detected by an IR sensor, which triggers the MCU to activate the CCD.

The diffracted light is directed to the CCD and the spectral data from the CCD is converted to digital form by an ADC. The spectral data is then displayed or transferred to an external device.



Ben Logan PSE

#### **Background and Motivations**

- Laser induced break-down spectroscopy (LIBS) is a method that uses a laser pulse to generate plasma on a sample surface, from the plasma a spectrometer can be used for elemental analysis based on the emitted light.
- LIBS works by a process called atomic emission spectroscopy
- The use of a LIBS system employs measures to tackle both, cost and speed.
- Identifying and analyzing inorganic samples
- Design and build a LIBS system that is both cost effective and easy to use for students and institutions.
- Assist researchers and scientists in the exploration and understanding of space.



Ben Logan PSE

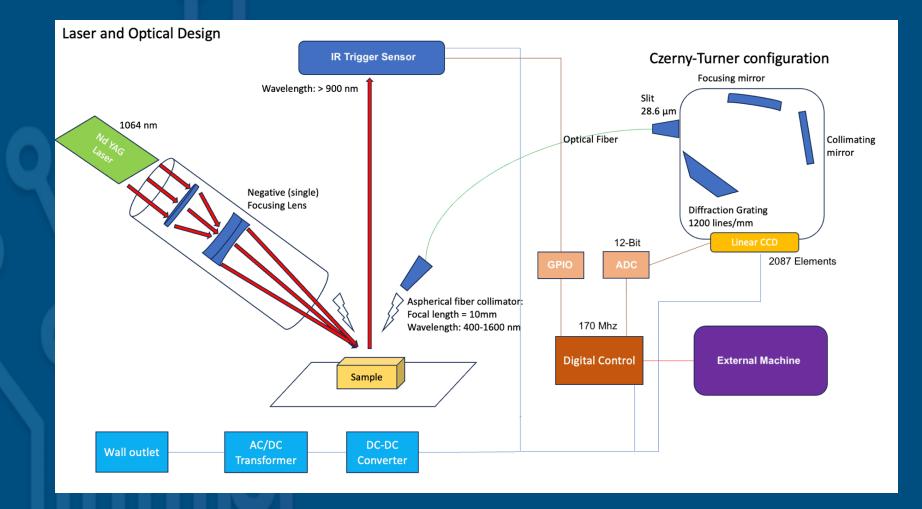
#### Goals

- Create a laser system that will consistently generate a plasma plume.
- Create a LIBS system that produces measurement results with less than 10% variance over 5 samples.
- Use of the LIBS system to identify known inorganic sample within 90% accuracy.
- LIBS system is controlled digitally.
- Convert analog spectrometer data into digital form.
- Output analyzed results in under a minute.
- Powered by wall outlet.



Faisal Abdullah ECE

#### Schematic Prototype:





## Engineering Requirements

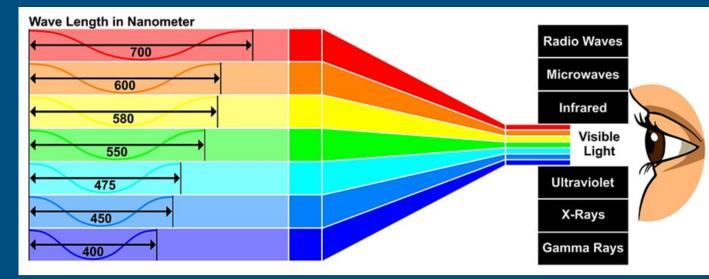
Laser Strength	1000 - 1200 Watt laser (Peak power-pulsed output)
Creation of plasma	Pulse width 6-8 ns, Spot area 1-5 mm
Identify object	To within 90% accurate of its expected spectral emission
Emission measurement results	Results are with less than 10% variance over 5 samples
Results output	LIBS sample results in under a minute
Diffraction grating	600-1200 lines/mm
Q-switch for Laser	1 - 10 Hz pulse rate
Sensor Wavelength detection	300 nm - 1200 nm
Analog to digital resolution	12-bit
communication protocols	USART, SPI, I2C
Linear CCD Resolution	2048 pixel
Laser excitation sensor detection range	750 - 1100 nm
Digital Power Regulation Type	Linear DC-DC converter
Digital controller Speed	64 MHz
Total System cost	≥\$4,000
Number of sample data sets stored	>5
Laser excitation detection time	<1.6 us



# Objectives: Laser system

- To create a lens system to extend the focal point of the beam
- Create a measurable amount of plasma.
- Design the system so it can be operated in a safe manner.







Ben Logan PSE

#### Laser Selection

When selecting the laser for our project it needed to meet several criteria for our needs.

- The laser must create plasma
- Be within budget
- Be relatively transportable
- Be operated and maintained in a safe manner
- Be compatible with the system as a whole



Power Specification for the Laser										
Power	1000 W (Peak Power)									
Frequency	1-10 Hz									
Power Supply	110 V									
Pulse Energy	Single Pulse ≥ 160 mJ, Double Pulse ≥ 270 mJ, Multi-pulse ≥ 700 mJ									
Spot Area	1-5 mm / 0.03-0.019 in									
Laser Housing/Cooling	49x32x31cm									
Pulse Width	8 ns									

The laser selected is the "Q Switch ND YAG Laser Machine For Tattoo Removal"



Ben Logan PSE

### Laser Testing and Safety Housing

We have conducted several tests with our laser. The main criteria for the laser is that it will create plasma for the spectrometer to measure.







#### Objectives: Spectrometer System

- Determine the spectral range of the system.
- Choose a gradient that suits the spectral range and resolution.
- Create an optimal system for spectroscopy: Design a slit entrance, collimating mirror, and focusing mirror.
- Determine location in system for light to enter a fiber-optic cable to connect to the spectrometer.
- Select the correct detector array based on the needs for the system. (system of detector, pixel size, quantum efficiency, read-out noise).

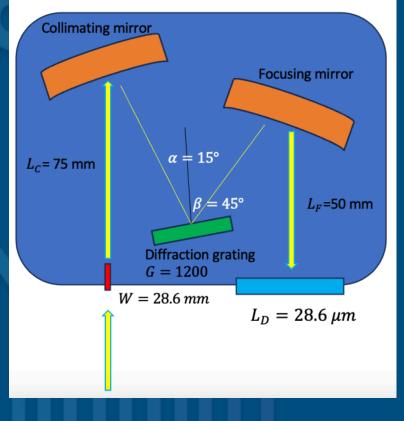


Steve Styrk PSE

#### Spectrometer Design:

#### Φ=30°

Optical performance, diffraction efficiency, and practical considerations.



#### Requirements:

- Determine spectral range Visible (400 700 nm)
- Geometry
- Diffraction grating
- Slit size
- Detector size

#### Key Design Concepts:

- Choose a geometry: 30-degree angle geometry
- Selection of grating -Blaze wavelength (500 nm)
- Reduce stray light
- Alignment considerations



Getting light efficiently to the spectrometer



56 cm B & W Tek Fiber Patch Cord SMA905-FC 600-micron core



#### Ocean Insight 74-Vis Collimating lens:

- Lens for visible-NIR (350-2500 nm)
- Focal length: 10 mm
- f/2 BK-7 glass



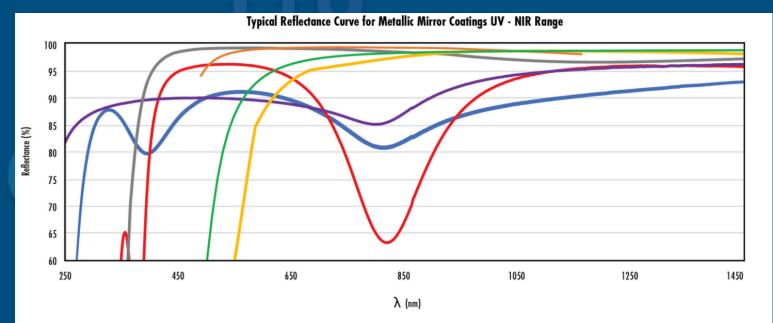
Brand	Groove Density (groove/mm)	Wavelength range (nm)	Blaze wavelength (nm)	Dimensions (mm)	Price
Edmund Optics	600	200-900	500	12.7x12.7 25.0x25.0	\$80 \$134
Edmund Optics	<mark>1200</mark>	<mark>200-1600</mark>	<mark>500</mark>	12.5x12.5 <mark>25.0x25.0</mark>	\$80 <mark>\$134</mark>
Thor	600	200-900	500	12.7x12.7 25.0x25.0	\$76.58 \$125.77
Thor	1200	200-1600	500	12.7x12.7 25.0x25.0	\$76.58 \$125.77

500 nm Blaze Wavelength: 600 Grooves/mm 80 THORLA Absolute Efficiency (%) 70· 60 -50-40-30-20-Perpendicular 10 Average 500 nm Parallel 225 300 375 450 525 600 675 750 825 900 975 Wavelength (nm)

Czerny Turner Spectrometer Diffraction grating:

- Plane ruled reflective grating
- 1200 lines per mm
- Blaze wavelength of 500 nm





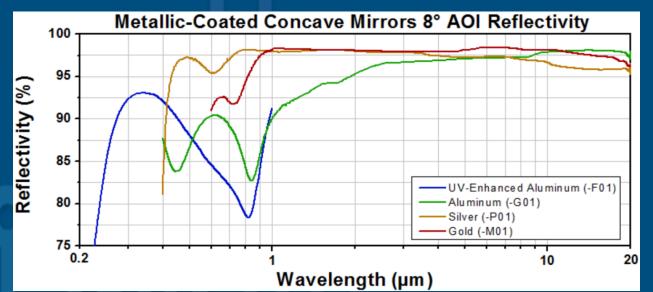
Protected Aluminum		— Enhance	ed Aluminum	— UV Ehand	ed Aluminum	— Prote	cted Gold	<b>—</b> Ba	re Gold	Protec	ted Silver	— Ultrafast Enhanced Silver	
Range (µm)	% Reflection	Range (µm)	% Reflection	Range (µm)	% Reflection	Range (µm)	% Reflection	Range (µm)	Range (µm) % Reflection		% Reflection	Range (µm)	% Reflection
0.4 - 0.7	85	0.45 - 0.65	95	0.25 - 0.45	89	0.7 - 2.0	96	0.7 - 0.8	94	0.45 - 2.0	98	0.6 - 1.0	99
0.4 - 2.0	90	-	-	0.25 - 0.70	85	2.0 - 10.0	96	0.8 - 2.0	97	2.0 - 10.0	98		
					2.0 - 12.0	98							



Steve Styrk PSE

#### Czerny Turner Crossed Spectrometer: Concave mirrors

- Cost vs efficiency
- Protected aluminum



Brand	Part number	Coating	Reflectivity	Wavelength range(nm)	Aperture	EFL (mm)	Diameter (mm)	Price
Edmund Optics	43-465	Protected Aluminum	>90%	400-2000	f/1	25	25	\$46
Edmund Optics	<mark>43-471</mark>	Protected Aluminum	<mark>&gt;90%</mark>	<mark>400-2000</mark>	<mark>f/2</mark>	<u>100</u>	<u>50</u>	<mark>\$55</mark>
Thor	CM127-012- G01	Protected Aluminum	>90%	450-2000	f/1	25	12.7	\$42.51
Thor	CM254-075- G01	Protected Aluminum	<mark>&gt;90%</mark>	<mark>450-2000</mark>	<mark>f/3</mark>	75	25	<mark>\$66.24</mark>

Steve Styrk PSE

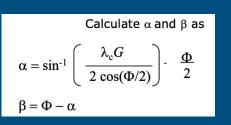
Czerny Turner Spectrometer Concave mirrors: Focusing mirror and collimation mirror

- Edmund Optics
- Thor Labs

# Spectrometer calculations for Design:

Step Method of Creating a spectrometer system:

- Select Geometry: Φ
- Select diffraction grating
- Find diffraction angles
- Select a detector width
- Calculate Focal length of focus mirror
- Calculate focal length of collimation mirror
- Determine input slit size



Minimum wavelength: Maximum wavelength: Wavelength range: Resolution: Center wavelength:	$ \begin{array}{l} \lambda_1 \\ \lambda_2 \\ \lambda_2 - \lambda_1 \\ \Delta \lambda \\ \lambda_c = (\lambda_2 + \lambda_1)/2 \end{array} $
Angle of incidence: Diffraction angle:	$ \begin{aligned} & \alpha \\ & \beta \\ & \Phi = \alpha + \beta \end{aligned} $
Grating groove density: Focal length collimation: Focal length focus: Detector width: Input slit width:	$G \\ L_{\rm C} \\ L_{\rm F} \\ L_{\rm D} \\ \omega_{\rm slit}$

Calculate focal length of focus lens/mirror:  $L_{\rm F}$  $L_{\rm F} = \frac{L_{\rm D}\cos(\beta)}{G(\lambda_2 - \lambda_1)}$ 

> Calculate focal length of collimation lens/mirror:  $L_{\rm C}$  $L_{\rm c} = L_{\rm F} \ \frac{\cos(\alpha)}{M\cos(\beta)}$

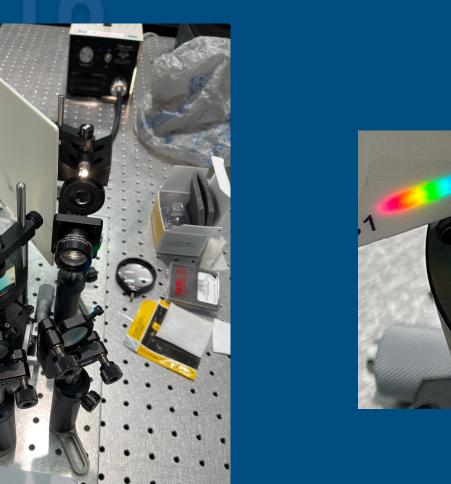
Calculate input slit width: 
$$w_{\text{slit}}$$
  
 $w_{\text{slit}} = \frac{G \Delta \lambda L_{\text{c}}}{\cos(\alpha)}$ 



#### Steve Styrk PSE

17

# Spectrometer Sub-System Component Testing:







### Fiber coupling power

Core Diamater	Power coupling
<b>50</b> µm	19.83 $\mu W$
600 <i>µm</i>	1.2 mW
1000 µm	1.368 mW



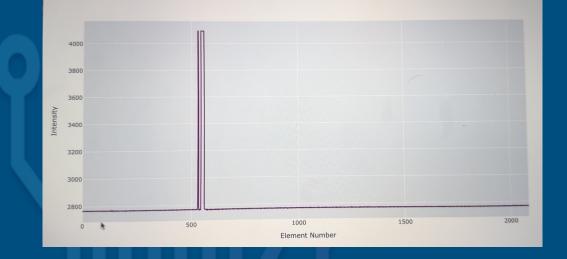






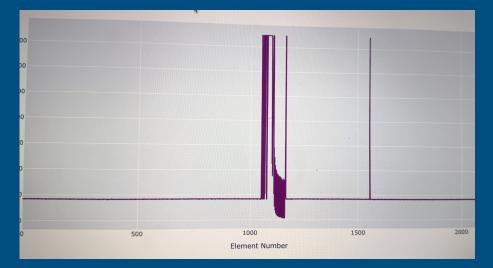
#### CCD Spectral responce

#### 532 Green laser pointer







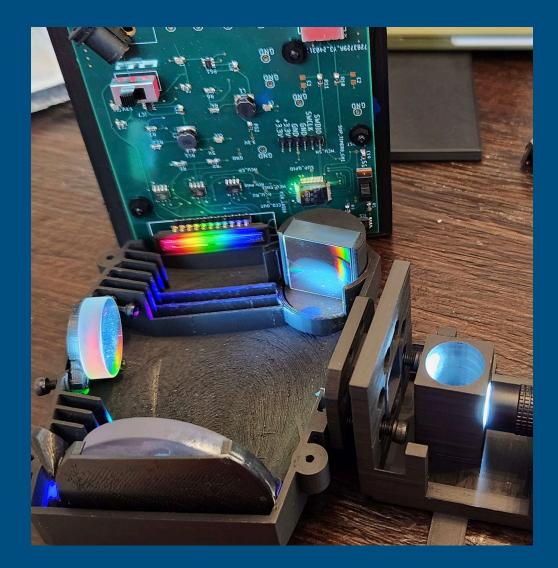


## Spectrometer Alignment











#### **Objectives: Digital Control**



#### **Detect Laser Firing Sequence**

Capture & Convert Spectral Sample Emissions

**Output Measurement Results** 

22

## Digital Controller Technology Comparison

- Sufficient speed 20 MHz 50 MHz
- Sufficient I/O Resources 19 or more
- Low Cost

Liam Collins ECE

	Microcontroller	FPGA	CPLD
Speed	1 MHz- 1 GHz	10 KHz - 500 MHz	2 MHz - 22 MHz
I/O	2 - 293	32 - 2072	5 - 360
Cost	\$2 - \$3053	\$34 - \$173901	\$9 - \$598
Design Complexity	100s of features	1000,000+ logic blocks	1000s of logic elements
Hardware Type	Fixed Hardware	Fully Customizable	Fully Customizable

### Spectral Emission Sensor Technology Comparison

- High Dynamic Range
- Sufficient Speed
- Low Cost

	CCD Sensor	CMOS Sensor
Dynamic Range	66 dB - 90 dB	52 dB - 73 dB
Cost	\$30 - \$900	\$800 - \$2000
Power Consumption	160 mW - 400 mW	0.5 W - 3.85 W
Data Transfer Speed	6 MHz - 30 MHz	10 MHz- 80 MHz



## Software Technology Comparison

- Portability
- Popularity in Data analysis



	Rust	Python	C++
Speed ( Binary Tree Sorting)	1.19s	50s	1s
Popularity ( Github Pull Requests )	13th	1st	5th
Code Processing	Compiler	Interpeter	Compiler



## MCU Comparison

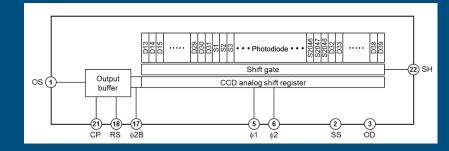
		PC10	PB9	PB8	PB7	PB6	PB5	25	PB3	ő	З	đ	PD3	PD2	Б	500	പ				
		۲ ۲	1		Ē	1	1				1	1	1	E		1	۲ ۲				
,	/	64	63	62	5	60	59	28	22	56	55	5	22	52	5	22	49				
PC11 🗆	1																	48	Þ	PC8	
PC12	2																	47	Þ	PA15	
PC13 🗌	3																	46	Þ	PA14-B	00Т0
PC14-OSC32_IN	4																	45	Р	PA13	
PC15-OSC32_OUT	5																	44	Ρ	PA12 [P	-
VBAT	6																	43	Ρ	PA11 [F	2A9]
VREF+	7																	42	Ρ	PA10	
VDD/VDDA	8						1	C	)F	P	64	1						41	Ρ	PD9	
VSS/VSSA	9							-0	CI		0-	т						40	Ρ	PD8	
PF0-OSC_IN	10																	39	Ρ	PC7	
PF1-OSC_OUT	11																	38	Þ	PC6	
PF2-NRST	12																	37	Ρ	PA9	
PC0	13																	36	Ρ	PA8	
PC1	14																	35	Þ	PB15	
PC2	15																	34	Ρ	PB14	
РСЗ 🗌	16																	33	р	PB13	
	$^{\prime}$	17	3	19	20	2	22	23	24	25	26	27	28	29	30	31	32	/			
		PA0	PA1	PA2	PA3	PA4	PA5	PA6	PA7	PC4	PC5	PB0	PB1	PB2	PB10	PB11	PB12				



	STM32G474RET6	SPC5601PE F0MLH6	ATSAM3S1A B-AUR
ADC Sample Rate	250 ns	<1 us	1 us
Power Consumption	700 mW	725 mW	745 mW
GPIO	58	45	34
RAM	128 Kbyte	20 Kbyte	16 Kbyte

## CCD Comparison



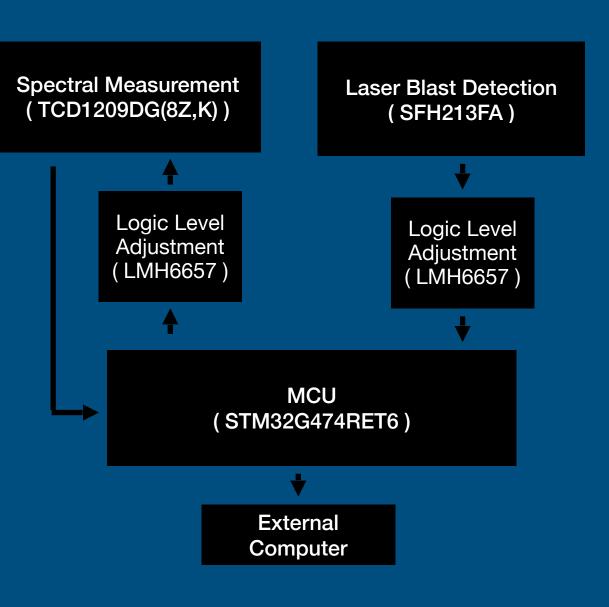




	TCD1209DG(8Z,K)	UPD3747D-A	UPD8828AD-A	
Price	\$48.61	\$46.23	\$73.92	
Dynamic Range	2000	250	1000	
Photocells	2048	7400	7500	
Max Frequency	20 MHz	22 MHz	20 MHz	

### **Digital Control Core Systems Overview**

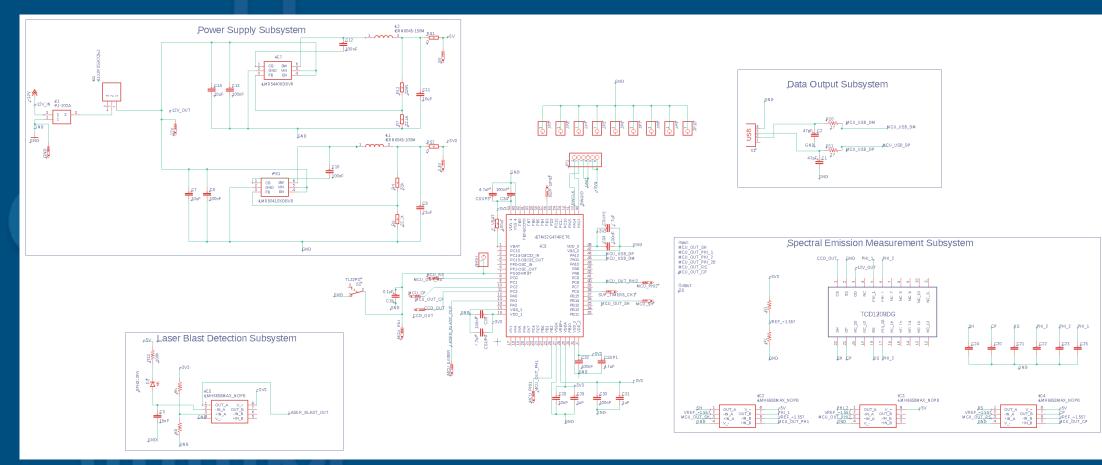
- Laser Excitation
  Detection
- Driving CCD
- ADC Trigger
- External Data Transfer
- Data Organization



Liam Collins

ECE

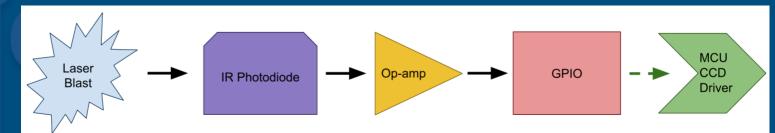
#### PCB Schematic

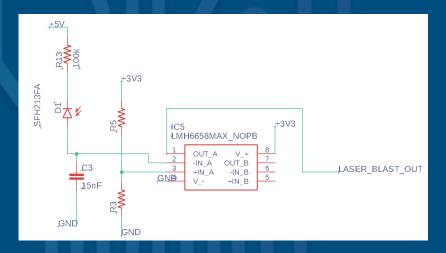


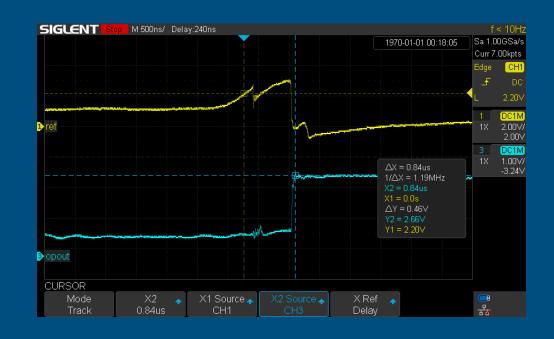


#### Laser Blast Detection Subsystem

- IR photodiode reversed biased at 5V
- Delay between detection and system start is 84 ns



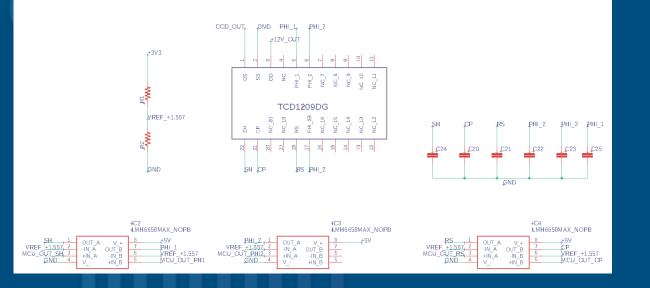


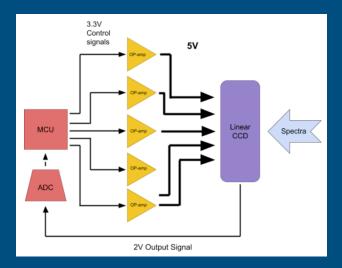


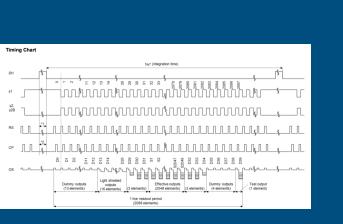


## Spectral Emission Measurement Subsystem

- CCD 12 V Supply
- 5 Driving Control Signals
- 3.3 V to 5 V Logic Shift
- Op Amps offer per signal flexibility



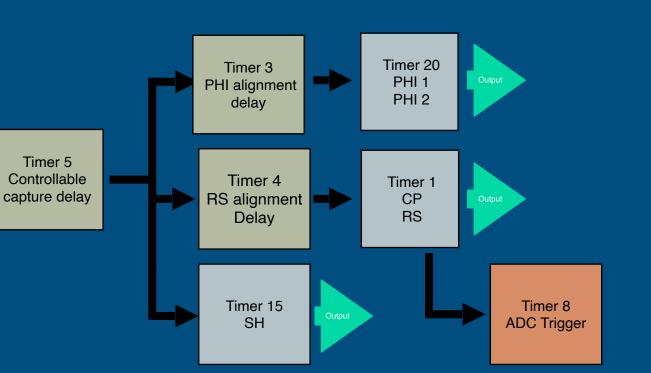




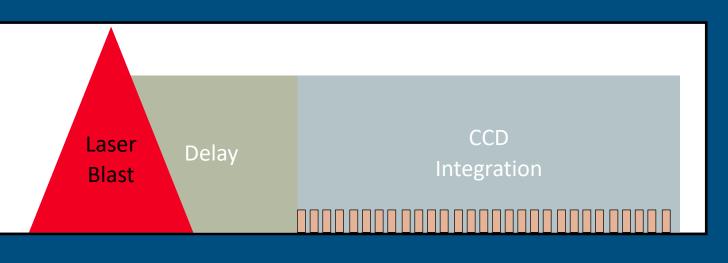


### MCU Timer Wave Shaping

- Provides non-blocking waveform generation
- 2088 cycles needed for an entire integration



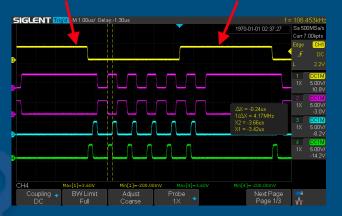




### MCU Selection Evolution

- Original MCU timers could only generate 2 complex waveforms. This could not create sufficient waveforms to accurately match the CCD's signal timing requirements
- Original MCU had limited options to trigger and sync timers
- An upgraded MCU of the same family was chosen to replace the old MCU. This MCU had sufficient complex timers and more options for triggering and syncing timers

Incorrect Original MCU Waveform: high duration when pulse is desired at each end



#### Old MCU timer triggering options

Table 115. TIM1 internal trigger connection							
Slave TIM	ITR0 (TS = 00000)	ITR1 (TS = 00001)	ITR2 (TS = 00010)	ITR3 (TS = 00011)			
TIM1	TIM15	TIM2	TIM3	TIM17 OC1			
Table 126. TIMx Internal trigger connection							
Slave TIM	ITR0 (TS = 00000)	ITR1 (TS = 00001)	ITR2 (TS = 00010)	ITR3 (TS = 00011)			
TIM15	TIM2	TIM3	TIM16_OC1	TIM17_OC1			
	Table 119. TIMx internal trigger connection						
Slave TIM	Slave TIM ITR0		ITR2	ITR3			
TIM2	TIM1	TIM15	TIM3	TIM14_OC1			
TIM3	TIM1	TIM2	TIM15	TIM14_OC1			
TIM4	TIM4 TIM1		TIM15	TIM14_OC1			

Upgraded MCU Waveform generation creating desired pulses and timing



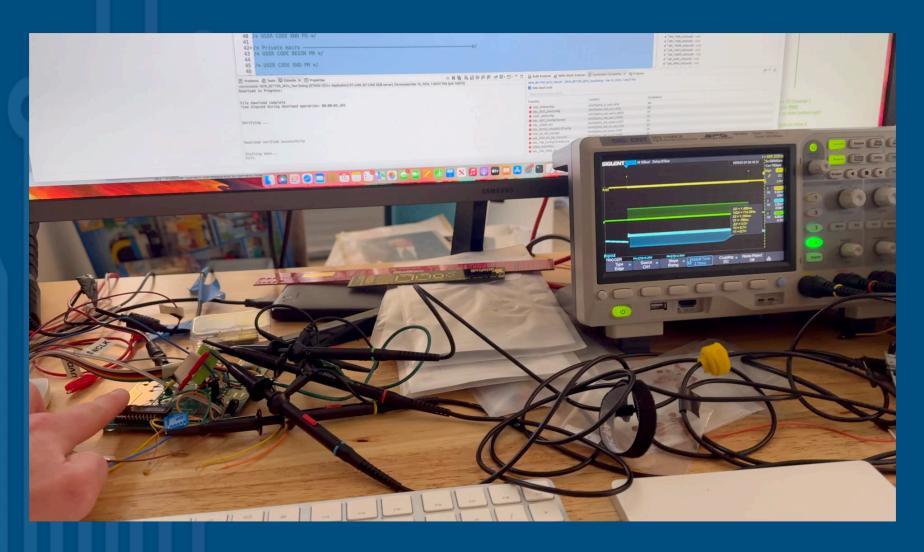
#### New MCU timer triggering options

11.3	Interconnection details
11.0	inter connection actuals

11.3.1 From timer (TIMx, HRTIM) to timer (TIMx)

	Table 61. Interconnect 1							
Timer input trigger signal	Timer input trigger source assignment							
	TIM1	TIM2	тімз	TIM4	TIM5	тімв	TIM15	TIM20
timx_itr0	-	tim1_trgo						
timx_itr1	tim2_trgo	-	tim2_trgo	tim2_trgo	tim2_trgo	tim2_trgo	tim2_trgo	tim2_trgo
timx_itr2	tim3_trgo	tim3_trgo	-	tim3_trgo	tim3_trgo	tim3_trgo	tim3_trgo	tim3_trgo
timx_itr3	tim4_trgo	tim4_trgo	tim4_trgo	-	tim4_trgo	tim4_trgo	tim4_trgo	tim4_trgo
timx_itr4	tim5_trgo	tim5_trgo	tim5_trgo	tim5_trgo	-	tim5_trgo	tim5_trgo	tim5_trgo
timx_itr5	tim8_trgo	tim8_trgo	tim8_trgo	tim8_trgo	tim8_trgo	-	tim8_trgo	tim8_trgo
timx_itr6	tim15_trgo	tim15_trgo	tim15_trgo	tim15_trgo	tim15_trgo	tim15_trgo	-	tim15_trgo
timx_itr7	tim16_oc	tim16_oc	tim16_oc	tim16_oc	tim16_oc	tim16_oc	xtim16_oc	tim16_oc
timx_itr8	tim17_oc	tim17_oc	tim17_oc	tim17_oc	tim17_oc	tim17_oc	tim17_oc	tim17_oc
timx_itr9	tim20_trgo	tim20_trgo	tim20_trgo	tim20_trgo	tim20_trgo	tim20_trgo	tim20_trgo	-
timx_itr10	hrtim_out_ scout2	hrtim_out_ scout2	hrtim_out_ scout2	hrtim_out_ scout2	hrtim_out_ scout2	hrtim_out_ scout2	hrtim_out_ scout2	hrtim_out_ scout2

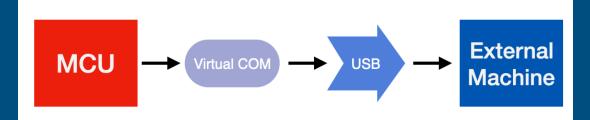
### Electrical systems Testing



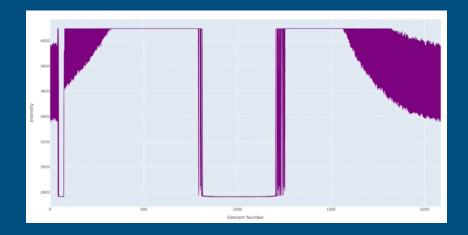


#### Data Output Subsystem

- MCU provides onboard USB support
- Serial Py used to capture the CCD data
- Plotly used for initial graphing
- Pandas used to write CCD data to a .CSV file for data portability

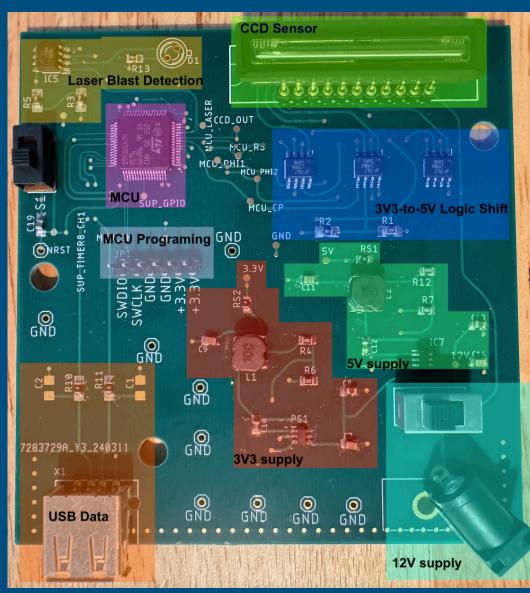






#### PCB Design

- Six layer stack up
- Signal-Ground-5V-3V-Ground-Signal
- 5 mm component spacing for Hand solder
- 20 mil traces for signal and power
- 0 ohm disconnects for troubleshooting
- Signal test points for monitoring and breakout expansion





# Objectives: Powered Systems

- Determine power requirements.
- Compare DC power source technologies.
- Determine subsystem power requirements.
- Compare tradeoffs of voltage regulator technologies.
- Design power converters for subsystems.



## **Power Requirements**

- Power Supply of the Laser.
- Q-switched Nd YAG laser requires 1 KW .
- Use the power supply that is included with th commercial laser.
- Safety and Time concern.
- System Power Distribution table

Item	Power	Voltage	Current
Q-Switched Nd YAG laser	1 KW	110 v	9 A
FT231XS-R	2.5 W <sub>1</sub>	5V	0.5 A
Laser Sensor	87 mW	3.6v	24 mA (40mA peak)
MCU	720 mW <sub>2</sub>	3.6V	180 mA
CCD sensors	400 mW₃	12V	0.5 A



### System Power Supply Comparison

- PCB Power Supply Sources
- WALL OUTLET (AC) VS DC
- DC batteries

Туре	Lithium-lon	Lead Acid	Lead-Carbon		
	Battery				
Cost / Price range	Most Expensive (up to 2000\$)	Low (20-200\$)	Moderate (100- 500\$)		
Weight	(7.5-15Kg)	35kg	(31- 35 kg )		
Energy density	200-300Wh kg-1	30-40 Wh kg−1	30-45 Wh kg−1		
Cycle life	High (~4000–5000)	Low (~500–1000)	Moderate (~1500–2000)		
Power density	High (800-900 W kg−1)	Low (~40–50 W kg-1)	Moderate (~100-500 W kg-1)		
DOD	High (~80–95%)	Low (~30–50%)	Moderate (~50–80%)		
Efficiency	Most efficient (90%)	Low (50%)	High (85%-90%)		

#### Power Source Technology Comparison



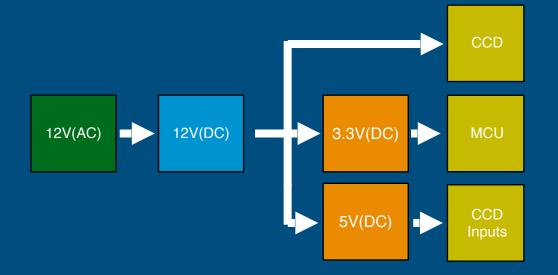
- DC batteries have more Stability than the AC wall outlet
- DC batteries require Recharging and replacement.
- The Cost of DC batteries are too high

Types	DC batteries	AC Wall outlet
Stability	More	Less
Recharging	Required	Not Required
Replacement	Yes	No
Cost	Expensive(\$20-\$500)	Cheap(\$10-\$15)
AC-DC convertor needed	No	Yes

### Power System Design

- Components power sources.
- Voltage Regulators
- CCD requires 12 V.
- 5 V voltage regulator will be used to supply CCD inputs and FT231XS-R.
- 3.3 V voltage regulator to supply the MCU.

Fried Abdullab



# Voltage Regulator Comparison

- Switching VS Linear Voltage Regulators
- power efficiency noise, Cost, heat, and design complexity .
- Linear regulators have less noise output .and more heat output.
- Switching regulators have less heat output and high efficiency.

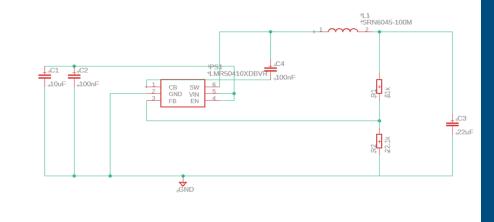
The noise issues produced by the switching regulator, we can overcome this by careful component placement and routing the PCB.

Voltage regulator type	Linear	Switching		
Design	Simple(non-reactive elements)	Complex(reactive elements)		
Efficiency	Low (30%-60%)	High ( 84%-97%)		
Heat output C	High (up to 160°C)	Less (20°C ~ 85°C )		
Noise/ripple voltage	Low (10 Vrms -20Vrms)	High ( 30mV)		
Overheat protection	Thermal shutdown protection	Overheat protection		
Step up / Step Down	Step down only	Step UP & Step down.		
		Buck & Boost		
Size	Small (1.00 mm × 1.00 mm)	Big (2.90 mm × 1.60 mm)		
Cost	Low (0.24\$)	High (\$4.53)		

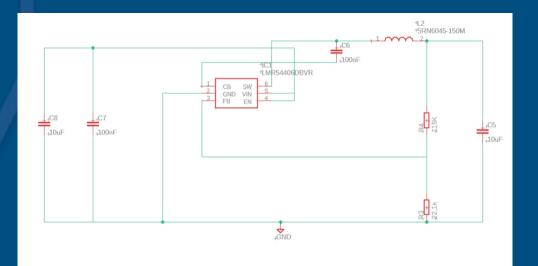


### Switching Voltage Regulators

- MCU Voltage Regulator Schematic (3.3 V)
- CCD inputs and FT231 Voltage regulator Schematic (5V)
- LMR50410XDBVR
- lower output ripple voltage.
- high efficiency
- Low cost

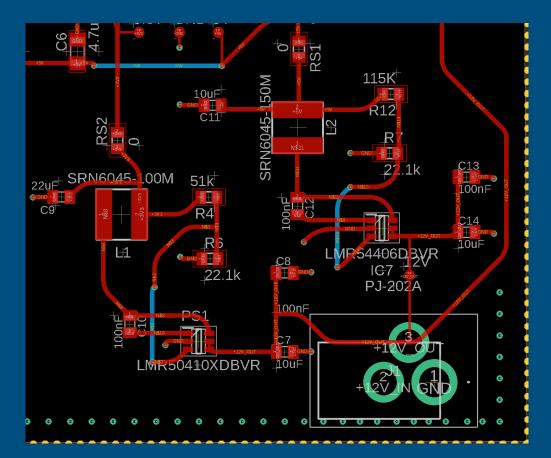






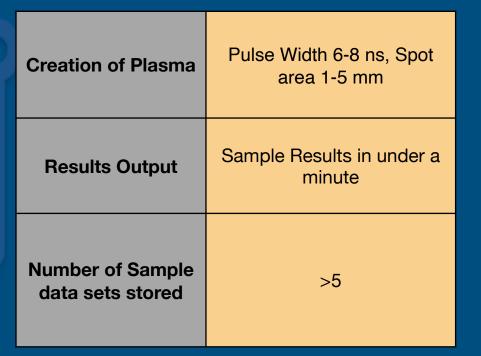
# **Regulator Design**

- Inductors perpendicular rotation to reduce magnetic coupling
- Space provided for additional thermal vias
- Prevent overheating.
- 0 ohm disconnects for each regulator output to test the regulators supply.





# Verified Engineering Requirements





45

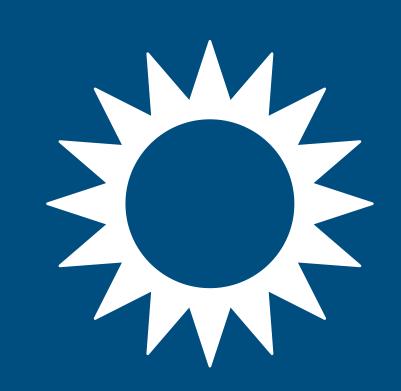
#### **Plasma Creation**

Calculations for plasma creation with Peak Power

 $\begin{array}{l} \mbox{peak power is } \frac{700 \mbox{ mJ}}{8 \mbox{ ns}} = 87.5 \mbox{ MW.} \\ \mbox{peak power is } \frac{270 \mbox{ mJ}}{8 \mbox{ ns}} = 33.75 \mbox{ MW.} \\ \mbox{Intensity} \, (W/cm^2) = \frac{87.5 \times 10^9 \mbox{ W}}{0.0001 \mbox{ cm}^2} \approx 8.75 \times 10^{14} \mbox{ W/cm}^2 \\ \mbox{Intensity} \, (W/cm^2) = \frac{87.5 \times 10^9 \mbox{ W}}{0.0005 \mbox{ cm}^2} \approx 1.75 \times 10^{14} \mbox{ W/cm}^2 \end{array}$ 



Ben Logan PSE



# Plasma Creation



# Plasma Creation

Parameter	Value	Parameter	Value
w 0	5.38E-06	<b>f</b> 1	100
λ	1.06E-06	<b>f</b> 2	-50
Rayleigh Range (output)	Formula	d	20
zR	8.55E-05	Effective Focal Length (output)	Formula
	85.5mm	system <i>f</i> <sub>system</sub>	-83.33333333



4	Surface Type	Comment	Radius	Thickness	Material	Coating	Clear Semi-D	ia	Chip Zone	Mech Semi-Dia	Conic	TCE x 1E-6
0	OBJECT Standard •		Infinity	Infinity			0.000		0.000	0.000	0.0	0.000
1	STOP Standard •		Infinity	0.000			10.000	U	0.000	10.000	0.0	0.000
2	(aper) Standard 🕶	L1S1	60.990	8.000	N-BK7		10.000	U	0.000	10.000	0.0	-
з	(aper) Standard •	L1S2	-60.9	20.000			10.000	U	0.000	10.000	0.0	0.000
4	(aper) Standard 🕶	L2S1	-50.0	3.000	N-BK7		9.000	U	0.500	9.500	0.0	-
5	(aper) Standard •	L2S2	100.0	0.000			9.000	U	0.500	9.500	0.0	0.000
6	Standard 🔻	Focal Point	Infinity	89.995			10.000	U	0.000	10.000	0.0	0.000
7	IMAGE Standard •		Infinity	-			10.000	U	0.000	10.000	0.0	0.000



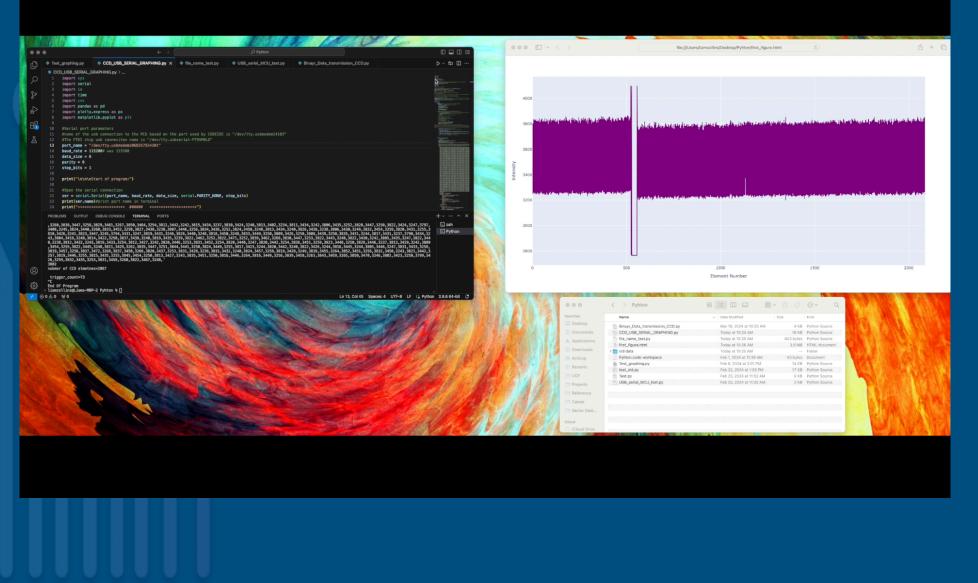
# Results Output

One of the specification requirements for the system is that it displays results in no more that one minute.



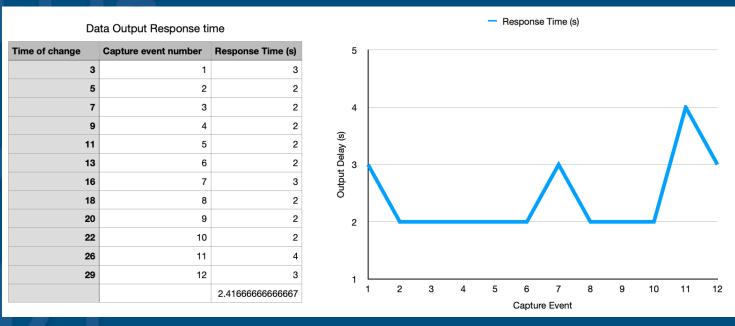


# **Results Output Testing**



# Results Output Testing

Average time to present data was 2.41s



### Samples Stored

The specification regarding the number of samples stored in the system is required to be greater than or equal to five.



## Sample Storage Specifications

Internal RAM of the MCU is 128KB the current program occupies 9.6 KB leaving 118.5 KB for data acquisition

With the ADC set to 12-bit and accounting for all 2087 CCD elements, using a 16-bit array allows for 28 samples to be stored before requiring transmission

	🗟 Build Analyzer 🗙 🚊 Static Stack Analyzer 🛞 Cyclomatic Complexity 🎬 Disassembly									
	NEW_BETTER_MCU_Test.elf - /NEW_BETTER_MCU_Test/Debug - Mar 24, 2024, 12:16:45 PM									
	Memory Regions	Memory Details								
	Region Start address End address Size Free Used Usage									
	RAM 0x20000000 0x2001ffff 128 KB 118.45 KB 9.55 KB 7.46%									
ELASH 0x08000000 0x0807ffff 512 KB 454.77 KB 57.23 KB 11.										

(x)= Variables 🗙 🔍	🍵 Breakpoint  🙀 Expressi	o 🔛 Disassemb	1010 0101 Registers	🚀 Live Expre 📟 SFRs 🛛 🗖
				ዀ 🎫 🕒 📑 🖻
Name		Туре		Value
> 🔎 buffer		uint16_t [1]		0x2001ffe0
(×)= buffer_size		uint16_t		2048
CCD_Output		uint16_t [2089]		0x2001ef8c
> 🔛 [099]		uint16_t [100]		0x2001ef8c
> 🧮 [100199]		uint16_t [100]		0x2001f054
> [200299]	]	uint16_t [100]		0x2001f11c
> 🔛 [300399]	]	uint16_t [100]		0x2001f1e4
> 🔛 [400499]	]	uint16_t [100]		0x2001f2ac
> 🧱 [500599]	]	uint16_t [100]		0x2001f374
> 🧮 [600699]	]	uint16_t [100]		0x2001f43c
> 🧱 [700799]		uint16_t [100]		0x2001f504
> 🧮 [800899]	]	uint16_t [100]		0x2001f5cc
> 🧱 [900999]	]	uint16_t [100]		0x2001f694
> 🧮 [1000109	99]	uint16_t [100]		0x2001f75c
> 🔚 [11001199	9]	uint16_t [100]		0x2001f824
> 🧮 [1200129	9]	uint16_t [100]		0x2001f8ec
> 🧮 [1300139	9]	uint16_t [100]		0x2001f9b4
> 🧮 [1400149	99]	uint16_t [100]		0x2001fa7c
> 🧱 [1500159	99]	uint16_t [100]		0x2001fb44
> 🧮 [1600169	99]	uint16_t [100]		0x2001fc0c
> 🧮 [1700179	9]	uint16_t [100]		0x2001fcd4
> 🧱 [1800189	99]	uint16_t [100]		0x2001fd9c
> 🧱 [1900199	99]	uint16_t [100]		0x2001fe64
> 🔚 [2000208	88]	uint16_t [89]		0x2001ff2c
(×)= i		int		0
(×)=j		int		536879160
(×)= delay_var_1		int		134218237
(×)=test_2		int		0
> 🥭 string		char [6]		0x2001ef84



# Sample Storage Specifications

Continuous sample transmission allows for an extremely large number of samples to be stored, as long as the sampling delay exceeds approximately 5 seconds

	Name	^	Date Modified	Size		Kind
1	CCD_OUTPUT_Feb_1_2024_Time11h40m25.csv		Feb 1, 2024 at 11:40 AM		19 KB	CSV Document
	CCD_OUTPUT_Feb_1_2024_Time11h43m18.csv		Feb 1, 2024 at 11:43 AM		19 KB	CSV Document
1	CCD_OUTPUT_Feb_1_2024_Time11h46m14.csv		Feb 1, 2024 at 11:46 AM		19 KB	CSV Document
	CCD_OUTPUT_Feb_1_2024_Time11h47m07.csv		Feb 1, 2024 at 11:47 AM		19 KB	CSV Document
1	CCD_OUTPUT_Feb_1_2024_Time11h47m53.csv		Feb 1, 2024 at 11:47 AM		19 KB	CSV Document
D	CCD_OUTPUT_Feb_1_2024_Time11h48m28.csv		Feb 1, 2024 at 11:48 AM		19 KB	CSV Document
L	CCD_OUTPUT_Feb_1_2024_Time11h49m07.csv		Feb 1, 2024 at 11:49 AM		19 KB	CSV Document
B	CCD_OUTPUT_Feb_1_2024_Time12h05m37.csv		Feb 1, 2024 at 12:05 PM		19 KB	CSV Document
L	CCD_OUTPUT_Feb_1_2024_Time12h05m39.csv		Feb 1, 2024 at 12:05 PM		19 KB	CSV Document
B	CCD_OUTPUT_Feb_1_2024_Time12h05m48.csv		Feb 1, 2024 at 12:05 PM		19 KB	CSV Document
12	CCD_OUTPUT_Feb_1_2024_Time12h06m16.csv		Feb 1, 2024 at 12:06 PM		19 KB	CSV Document
	CCD_OUTPUT_Feb_1_2024_Time12h06m18.csv		Feb 1, 2024 at 12:06 PM		19 KB	CSV Document
5	CCD_OUTPUT_Feb_1_2024_Time12h06m39.csv		Feb 1, 2024 at 12:06 PM		19 KB	CSV Document
	CCD_OUTPUT_Feb_1_2024_Time12h06m41.csv		Feb 1, 2024 at 12:06 PM		19 KB	CSV Document
L	CCD_OUTPUT_Feb_1_2024_Time12h06m43.csv		Feb 1, 2024 at 12:06 PM		19 KB	CSV Document
	CCD_OUTPUT_Feb_1_2024_Time12h07m10.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
1	CCD_OUTPUT_Feb_1_2024_Time12h07m16.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
	CCD_OUTPUT_Feb_1_2024_Time12h07m19.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
L	CCD_OUTPUT_Feb_1_2024_Time12h07m22.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
B	CCD_OUTPUT_Feb_1_2024_Time12h07m25.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
1	CCD_OUTPUT_Feb_1_2024_Time12h07m27.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
1	CCD_OUTPUT_Feb_1_2024_Time12h07m32.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
1	CCD_OUTPUT_Feb_1_2024_Time12h07m35.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
B	CCD_OUTPUT_Feb_1_2024_Time12h07m36.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
L	CCD_OUTPUT_Feb_1_2024_Time12h07m39.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
19	CCD_OUTPUT_Feb_1_2024_Time12h07m41.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
-	CCD_OUTPUT_Feb_1_2024_Time12h07m43.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
	CCD_OUTPUT_Feb_1_2024_Time12h07m44.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
1	CCD_OUTPUT_Feb_1_2024_Time12h07m45.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
19	CCD_OUTPUT_Feb_1_2024_Time12h07m46.csv		Feb 1, 2024 at 12:07 PM		21 KB	CSV Document
19	CCD_OUTPUT_Feb_1_2024_Time12h08m17.csv		Feb 1, 2024 at 12:08 PM		21 KB	CSV Document
	CCD_OUTPUT_Feb_1_2024_Time12h08m18.csv		Feb 1, 2024 at 12:08 PM		21 KB	CSV Document



### Laser Blast Detection

The delay between detection of the laser blast and the start of the CCD integration sequence. The time between the diode excitation, and the MCU Starting the integration sequence of the CCD should be less than or equal to 1.6 us

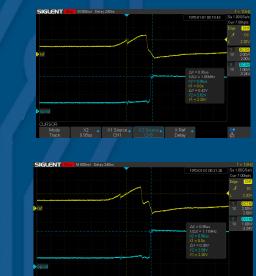


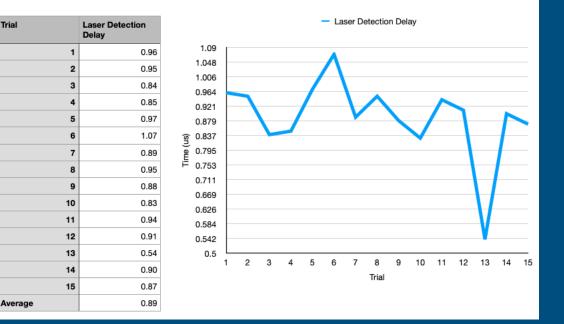


#### Laser Blast Detection

The designed sub-system has an average delay of 0.890 us between diode excitation and the start of the CCD integration sequence.









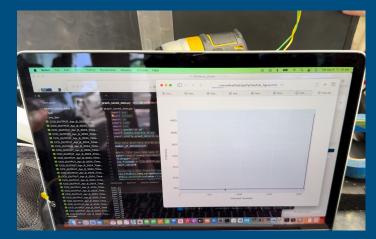
### Results

- All subsystems functioning Independently
- Insufficient light entering system
- Combinations of different Light guides, Collimating lenses, and CCD integration times attempted
- More detailed coverage in the Demo video

# Longer CCD Integration with new Light guide



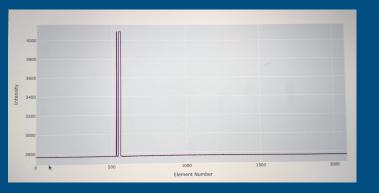
Original CCD Integration with original Light guide



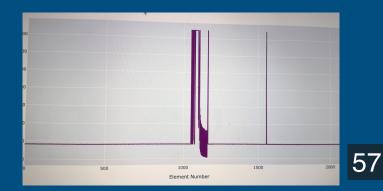
#### CCD and Spectrometer Test results Correct

**Overall system Test results** 

532 Green laser pointer



#### HeNe Laser



# Current and Projected Budget

We are using 3D printed components to hold the Optics for the laser and the Mirrors and Diffraction Grating for the Spectrometer

The final PCB has been implemented in the system

This budget Reflects the cost of research and development of the entire system





Ben Logan PSE

## Potential Future Work

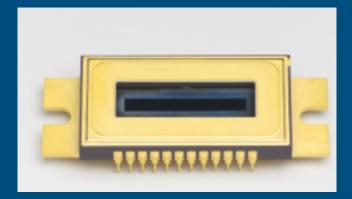
- Aquire sponsorship
- Integrate new components
  - Faster & more sensitive CCD
  - Higher quality Collimating lens

#### Edmund Optics Collimator



Spectroscopy linear CCD Price: ~\$500

#### Hamamatsu S7031



#### Spectroscopy linear CCD Price: ~\$2000



### Work Distribution:

 $\succ$  Benjamin Logan – Laser, alignment, focusing optical system.

- ≻ Faisal Abdullah Salim Al-Quaiti Power System (excluding laser).
- > Liam Collins Digital control, sensors, and data output of system.
- Stephen Styrk Spectroscopy system and the sample emission optical guidance system.



Ben Logan PSE